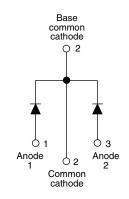


Vishay Semiconductors

Schottky Rectifier, 2 x 20 A





PRODUCT SUMMARY					
Package	TO-247AC				
I _{F(AV)}	2 x 20 A				
V_R	15 V				
V _F at I _F	See Electrical table				
I _{RM} max.	600 mA at 100 °C				
T _J max.	125 °C				
Diode variation	Common cathode				
E _{AS}	10 mJ				

FEATURES

- 125 °C T_J operation (V_R < 5 V)
- Optimized for OR-ing applications
- Ultra low forward voltage drop
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Designed and qualified according to JEDEC-JESD47
- Material categorization: For definitions of compliance please see www.vishav.com/doc?99912





ROHS COMPLIANT HALOGEN FREE

DESCRIPTION

The VS-40L15CW... center tap Schottky rectifier module has been optimized for ultra low forward voltage drop specifically for the OR-ing of parallel power supplies. The proprietary barrier technology allows for reliable operation up to 125 °C junction temperature. Typical applications are in parallel switching power supplies, converters, reverse battery protection, and redundant power subsystems.

MAJOR RATINGS AND CHARACTERISTICS							
SYMBOL	CHARACTERISTICS	VALUES	UNITS				
I _{F(AV)}	Rectangular waveform	40	A				
V _{RRM}		15	V				
I _{FSM}	t _p = 5 μs sine	700	A				
V _F	19 Apk, T _J = 125 °C (per leg, typical)	0.25	V				
T _J		- 55 to 125	°C				

VOLTAGE RATINGS								
PARAMETER	SYMBOL	TEST CONDITIONS	VS-40L15CWPbF	VS-40L15CW-N3	UNITS			
Maximum DC reverse voltage	V _R	T ₁ = 100 °C	15	15	V			
Maximum working peak reverse voltage	V_{RWM}	1J = 100 C	15	15	\ \ \			

ABSOLUTE MAXIMUM RATINGS								
PARAMETER		SYMBOL	TEST COND	VALUES	UNITS			
Maximum average forward current	per leg		50 % duty cycle at T _C = 86 °C, rectangular waveform		20			
See fig. 5	per device	I _{F(AV)}			40	Α		
Maximum peak one cycle			5 μs sine or 3 μs rect. pulse	Following any rated load condition and with	700	A		
non-repetitive surge current per leg See fig. 7		I _{FSM}	10 ms sine or 6 ms rect. pulse	rated V _{RRM} applied	330			
Non-repetitive avalanche energy per leg E _{AS}		E _{AS}	T _J = 25 °C, I _{AS} = 2 A, L = 5 mH		10	mJ		
		Current decaying linearly to zero in 1 μ s Frequency limited by T_J maximum $V_A = 1.5 \times V_R$ typical		2	Α			



VS-40L15CWPbF, VS-40L15CW-N3

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ELECTRICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CONDITIONS			MAX.	UNITS	
Maximum forward voltage drop per leg See fig. 1		19 A	T _{.1} = 25 °C	1	0.41	V	
	V _{FM} ⁽¹⁾	40 A	1J=25 C	-	0.52		
	VFM ('')	19 A	T _{.1} = 125 °C	0.25	0.33		
		40 A	1j = 125 C	0.37	0.50		
Reverse leakage current per leg	I _{RM} ⁽¹⁾	T _J = 25 °C	V Datad V	-	10	mA	
See fig. 2	IRM (")	T _J = 100 °C	V_R = Rated V_R	-	600	IIIA	
Threshold voltage	V _{F(TO)}	T -T movimum		0.1	82	V	
Forward slope resistance	r _t	$T_J = T_J$ maximum		7	.6	mΩ	
Maximum junction capacitance per leg	C _T	V _R = 5 V _{DC} (test signal ran	-	2000	pF		
Typical series inductance per leg	L _S	Measured lead to lead 5 n	8	-	nH		
Maximum voltage rate of change	dV/dt	Rated V _R	10 000		V/µs		

Note

 $^{(1)}\,$ Pulse width < 300 $\mu s,$ duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER	SY	YMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum junction temperature r	range	TJ		- 55 to 125	°C		
Maximum storage temperature r	ange	T _{Stg}		- 55 to 150	°C		
Maximum thermal resistance, junction to case per leg		R _{thJC}	DC operation See fig. 4	1.4			
Maximum thermal resistance, junction to case per package	esistance,		DC operation	0.7	°C/W		
Typical thermal resistance, case to heatsink	1	R _{thCS}	Mounting surface, smooth and greased	0.24			
Approximate weight				6	g		
Approximate weight				0.21	OZ.		
	ninimum		Non-lubricated threads	6 (5)	kgf · cm		
Mounting torque m	aximum		Non-iublicated tilleads	12 (10)	(lbf \cdot in)		
Marking device			Case style TO-247AC (JEDEC)	40L15CW			

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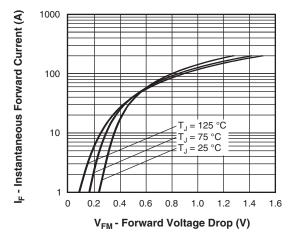


Fig. 1 - Maximum Forward Voltage Drop Characteristics

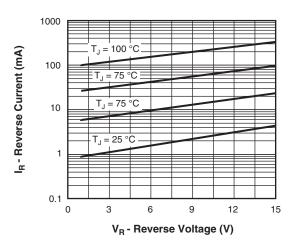


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

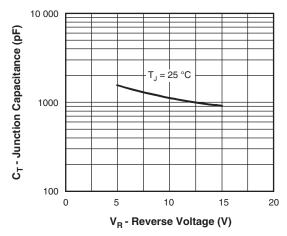


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

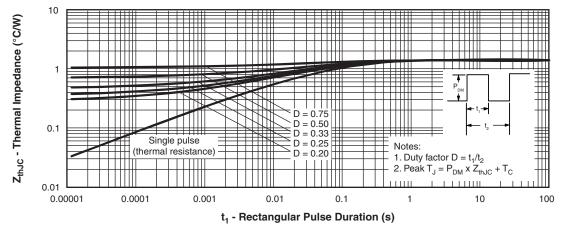


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

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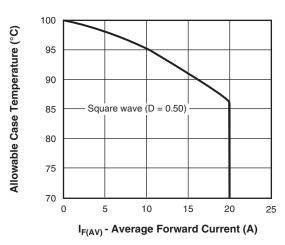


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

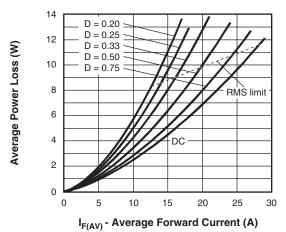


Fig. 6 - Forward Power Loss Characteristics

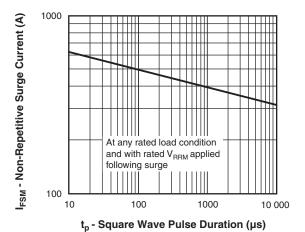


Fig. 7 - Maximum Non-Repetitive Surge Current

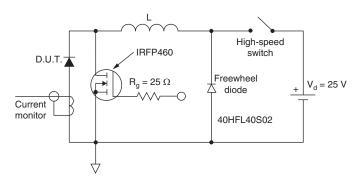


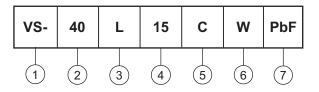
Fig. 8 - Unclamped Inductive Test Circuit

VS-40L15CWPbF, VS-40L15CW-N3

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ORDERING INFORMATION TABLE

Device code



- Vishay Semiconductors product

2 - Current rating (40 = 40 A)

3 - Schottky "L" series

- Voltage code (15 = 15 V)

5 - Circuit configuration:

C = Common cathode

6 - Package:

W = TO-247

7 - Environmental digit

• PbF = Lead (Pb)-free and RoHS compliant

• -N3 = Halogen-free, RoHS compliant, and totally lead (Pb)-free

ORDERING INFORMATION (Example)							
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION				
VS-40L15CWPbF	25	500	Antistatic plastic tube				
VS-40L15CW-N3	25	500	Antistatic plastic tube				

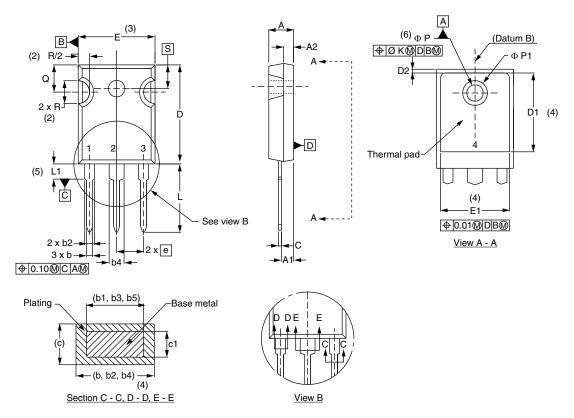
LINKS TO RELATED DOCUMENTS					
Dimensions <u>www.vishay.com/doc?95542</u>					
Dark mandring information	TO-247AC PbF	www.vishay.com/doc?95226			
Part marking information	TO-247AC -N3	www.vishay.com/doc?95007			



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TO-247AC - 50 mils L/F

DIMENSIONS in millimeters and inches



SYMBOL	MILLIMETERS		INC	NOTES	
STWIBOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.65	5.31	0.183	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.17	1.37	0.046	0.054	
b	0.99	1.40	0.039	0.055	
b1	0.99	1.35	0.039	0.053	
b2	1.65	2.39	0.065	0.094	
b3	1.65	2.34	0.065	0.092	
b4	2.59	3.43	0.102	0.135	
b5	2.59	3.38	0.102	0.133	
С	0.38	0.89	0.015	0.035	
c1	0.38	0.84	0.015	0.033	
D	19.71	20.70	0.776	0.815	3
D1	13.08	-	0.515	-	4

SYMBOL	MILLIN	IETERS	INC	HES	NOTES
OTWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
D2	0.51	1.35	0.020	0.053	
Е	15.29	15.87	0.602	0.625	3
E1	13.46	-	0.53	-	
е	5.46	BSC	0.215	BSC	
ØK	0.2	254	0.0)10	
L	14.20	16.10	0.559	0.634	
L1	3.71	4.29	0.146	0.169	
ØΡ	3.56	3.66	0.14	0.144	
Ø P1	-	7.39	-	0.291	
Q	5.31	5.69	0.209	0.224	
R	4.52	5.49	0.178	0.216	
S	5.51	BSC	0.217	BSC	

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension c and Q



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